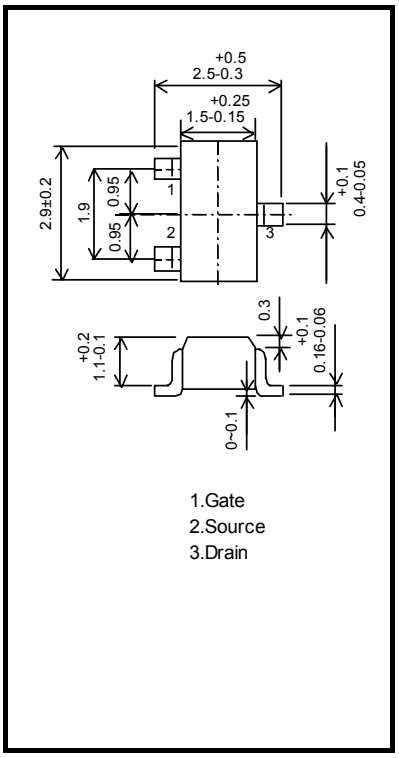
SSM3K7002F

High-Speed Switching Applications
Analog Switch Applications

Unit: mm



Weight: 0.012 g (typ.)

- Small package
- Low ON-resistance : R_{on} = 3.3 Ω (max) (@V_{GS} = 4.5 V)
  : R_{on} = 3.2 Ω (max) (@V_{GS} = 5 V)
  : R_{on} = 3.0 Ω (max) (@V_{GS} = 10 V)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DS}	60	V
Gate-source voltage		V_{GSS}	± 20	V
Drain current	DC	I_D	200	mA
	Pulse	I_{DP}	800	
Drain power dissipation (Ta = 25°C)		P_D	200	mW
Channel temperature		T_{ch}	150	°C
Storage temperature range		T_{stg}	−55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the TY Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ	Max	Unit
Gate leakage current		I_{GSS}	V_{GS} = ± 20 V, V_{DS} = 0	—	—	± 10	μA
Drain-source breakdown voltage		$V_{(BR)\ DSS}$	I_D = 0.1 mA, V_{GS} = 0	60	—	—	V
Drain cutoff current		I_{DSS}	V_{DS} = 60 V, V_{GS} = 0	—	—	1	μA
Gate threshold voltage		V_{th}	V_{DS} = 10 V, I_D = 0.25 mA	1.0	—	2.5	V
Forward transfer admittance		$\|Y_{fs}\|$	V_{DS} = 10 V, I_D = 200 mA	170	—	—	mS
Drain-source ON-resistance		$R_{DS\ (ON)}$	I_D = 500 mA, V_{GS} = 10 V	—	2.0	3.0	Ω
			I_D = 100 mA, V_{GS} = 5 V	—	2.1	3.2	
			I_D = 100 mA, V_{GS} = 4.5 V	—	2.2	3.3	
Input capacitance		C_{iss}	V_{DS} = 25 V, V_{GS} = 0, f = 1 MHz	—	17	—	pF
Reverse transfer capacitance		C_{rss}		—	1.4	—	pF
Output capacitance		C_{oss}		—	5.8	—	pF
Switching time	Turn-on delay time	$td_{(on)}$	V_{DD} = 30 V , I_D = 200 mA , V_{GS} = 0 to 10 V	—	2.4	4.0	ns
	Turn-off delay time	$td_{(off)}$		—	26	40	

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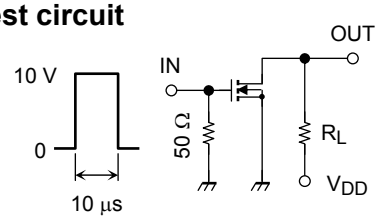
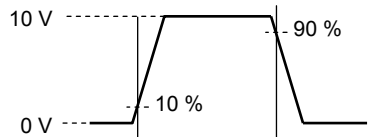
Switching Time Test Circuit

(a) Test circuit

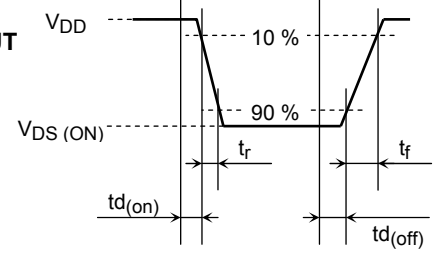


V_{DD} = 30 V
Duty ≦ 1%
V_{IN}: t_r, t_f < 2 ns
(Z_{out} = 50 Ω)
Common Source
Ta = 25 °C

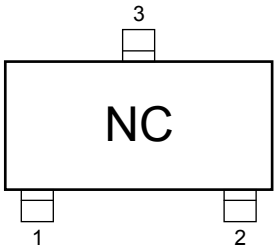
(b) V_{IN}



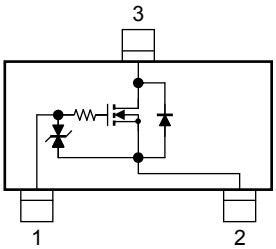
(c) V_{OUT}



Marking



Equivalent Circuit (top view)



Precaution

V_{th} can be expressed as the voltage between gate and source when the low operating current value is I_D= 0.25 mA for this product. For normal switching operation, $V_{GS\ (on)}$ requires a higher voltage than V_{th}, and $V_{GS\ (off)}$ requires a lower voltage than V_{th}.

(The relationship can be established as follows: $V_{GS\ (off)} < V_{th} < V_{GS\ (on)}$.)

Take this into consideration when using the device.

Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.